

**Source Code Evaluation, Development and Demonstration Software License Agreement**  
**ECS-SimpleLink - CC3200 Video Camera**

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b. Governing Language. This Agreement is written and executed in the English language and shall be authoritative and controlling, whether or not translated into a language other than English to comply with law or for reference purposes. If a translation of this Agreement is required for any purpose, including but not limited to registration of the Agreement pursuant to any governmental laws, regulations or rules, you shall be solely responsible for creating such translation.

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